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- All Outputs Are High for Invalid Input Conditions
- Also for Application as 4-Line-to-16-Line Decoders **3-Line-to-8-Line Decoders**
- **Diode-Clamped Inputs**

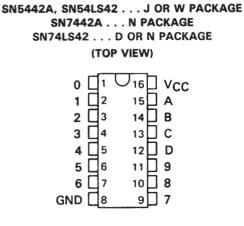
	TYPICAL	TYPICAL
TYPES	POWER	PROPAGATION
	DISSIPATION	DELAYS
'42A	140 mW	17 ns
'LS42	35 mW	17 ns

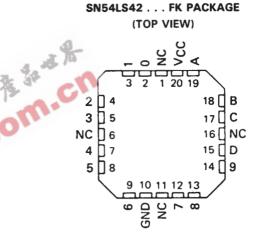
description

These monolithic BCD-to-decimal decoders decoding by the NAND gates. Full decoding of valid input logic ensures that all outputs remain off for all invalid input conditions. The '42A and 'LS42 feature inputs and outputs that are compatible for use with more other saturated low: ' consist of eight inverters and ten four-input

margins are typically one volt.

The SN5442A and SN54LS42 are characterized for operation over the full military temperature range of -55°C to 125°C. The SN7442A and SN74LS42 are characterized for operation from 0°C to 70°C.





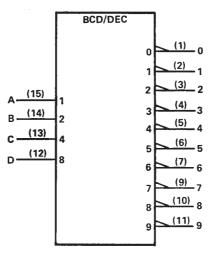
NC - No internal connection

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



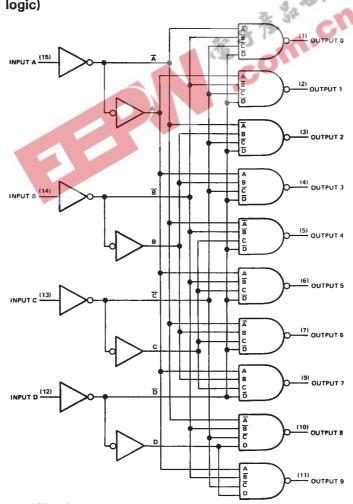
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logic symbol[†]



[†]This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

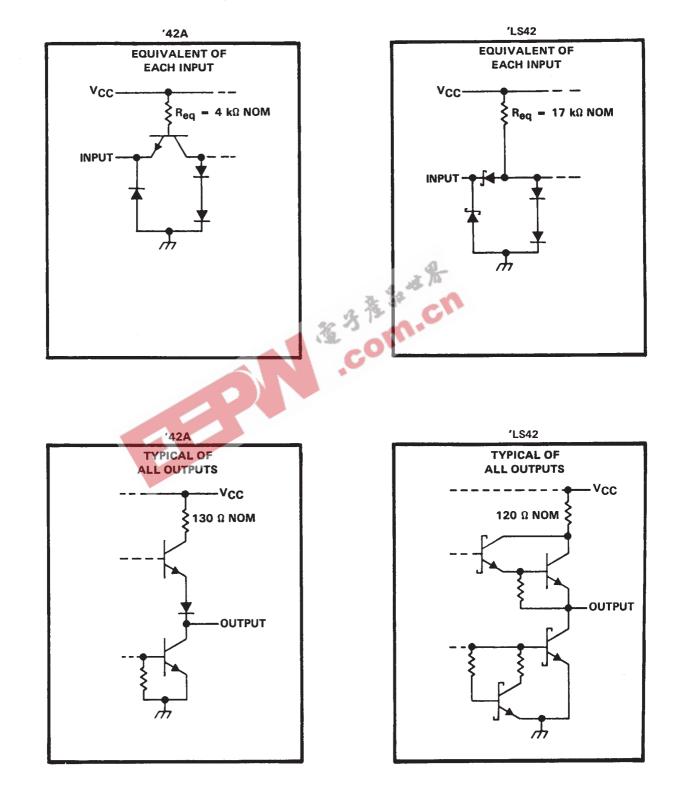
logic diagram (positive logic)



Pin numbers shown are for D, J, N, and W packages.



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schematics of inputs and outputs



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						FUNC	TION 1	ABLE						
		BCD I	NPUT			DECIMAL OUTPUT								
NO.	D	С	В	Α	0	1	2	3	4	5	6	7	8	9
0	L	L	L	L	L	н	н	н	н	н	Н	Н	Н	н
1	L	L	L	н	н	L	н	н	н	н	н	н	н	н
2	L	L	н	L	н	н	L	н	н	н	н	н	н	н
3	L	L	н	н	н	н	н	L	н	н	н	н	н	н
4	L	н	L	L	н	н	н	н	L	н	н	н	н	н
5	L	н	L	н	н	н	н	Н	н	L	н	Н	н	Н
6	L	н	н	L	н	н	н	н	н	н	L	н	н	н
7	L	н	н	н	н	н	н	н	н	н	н	L	н	н
8	н	L	L	L	н	н	н	н	н	н	н	н	L	н
9	н	L	L	н	н	н	н	н	н	н	н	н	н	L_
	н	L	н	Ļ	н	н	н	Н	н	н	Н	н	Н	н
	н	L	н	н	н	н	н	н	н	н	н	н	н	н
INVALID	н	н	L	L	н	н	н	н	н	н	н	н	н	н
Ň	н	н	L	н	н	н	н	н	н	н	н	н	н	н
-	н	н	н	L	н	н	н	н	н	н	н	н	н	н
	н	н	н	н	н	н	н	н	н	н	브릭	н	н	н

H = high level, L = low level absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)			•••••	7 V
Input voltage: '42A				5.5 V
'LS42				
Operating free-air temperature range:	SN5442A,	SN54LS42		55°C to 125°C
cherry?	SN7442A,	SN74LS42		0°C to 70°C
Storage temperature range				

NOTE 1: Voltage values are with respect to network ground terminal.

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recommended operating conditions

	S	SN5442A			SN7442A			
	MIN	NOM	MAX	MIN	NOM	МАХ	1	
Supply voltage, V _{CC}	4.5	5	5.5	4.75	5	5.25	V	
High-level output current, IOH			-800			- 800	μA	
Low-level output current, IOL			16			16	mA	
Operating free-air temperature, T _A	-55		125	0		70	°C	

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CONDITIONS [†]	SN5442A				UNIT		
			MIN	TYP‡	MAX	MIN	TYP‡	MAX	1
VIH	High-level input voltage		2			2			V
VIL	Low-level input voltage				0.8			0.8	V
VIK	Input clamp voltage	$V_{CC} = MIN$, $I_I = -12 \text{ mA}$			-1.5			-1.5	V
vон	High-level output voltage	V _{CC} = MIN, V _{IH} = 2V, V _{IL} = 0.8V, 1 _{OH} = -800 µA.	2.4	3.4		2.4	3.4		v
V _{OL}	Low-level output voltage	V _{CC} = MIN, V _{IH} = 2 V, V _{IL} = 0.8 V, I _{OL} = 16 mA	.C	0.2	0.4		0.2	0.4	v
կ	Input current at maximum input voltage	V _{CC} = MAX, V ₁ = 5.5 V	A		1			1	mA
ЧΗ	High-level input current	V _{CC} = MAX, V ₁ = 2.4 V			40			40	μA
4L	Low level input current	$V_{CC} = MAX, V_I = 0.4 V$			-1.6			-1.6	mA
los	Short-circuit output current §	V _{CC} = MAX	-20		-55	-18		-55	mA
Icc	Supply current	V _{CC} = MAX, See Note 2	1	28	41		28	56	mA

[†]For conditions shown as MIN or MAX, use the appropriate values specified under recommended operating conditions. [‡]All typical values are at $V_{CC} = 5 V$, $T_A = 25^{\circ}C$. [§]Not more than one output should be shorted at a time.

NOTE 2: I_{CC} is measured with all outputs open and all inputs grounded.

switching characteristics, $V_{CC} = 5 V$, $T_A = 25^{\circ}C$

	PARAMETER	TEST CONDITIONS	MIN	ТҮР	MAX	UNIT
^t PHL	Propagation delay time, high-to-low-level			14	25	ns
4 HL	output from A, B, C, or D through 2 levels of logic	CL = 15 pF,				
****	Propagation delay time, high-to-low-level			17	30	ns
^t PHL	output from A, B, C, or D through 3 levels of logic	$R_{\rm I} = 400 \ \Omega,$			30	115
	Propagation delay time, low-to-high-level	See Note 3		10	25	ns
^t PLH	LH output from A, B, C, and D through 2 levels of logic	See Note 5		10	20	115
	Propagation delay time, low-to-high-level	7		17	30	ns
^t PLH	output from A, B, C, and D through 3 levels of logic			.7	30	115

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



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recommended operating conditions

	S	SN54LS42					UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V _{CC}	4.5	5	5.5	4.75	5	5.25	V
High-level output current, IOH			-400			-400	μA
Low-level output current, IOL			4			8	mA
Operating free-air temperature, TA	-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	TEST CONDITIONS [†]			S	N54LS4	2	S	2		
	FARAMETER	IE)NS'	MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT
VIH	High-level input voltage				2			2			V
VIL	Low-level input voltage						0.7			0.8	V
VIK	Input clamp voltage	$V_{CC} = MIN,$	lj = -18 mA				1.5			-1.5	V
v _{он}	High-level output voltage	V _{CC} = MIN, V _{IL} = V _{IL} max,	V _{IH} = 2 V, I _{OH} = -400	μA	2.5	3.5		2.7	3.5		v
Val		V _{CC} = MIN,	V _{IH} = 2 V,	I _{OL} = 4 mA		0.25	0.4		0.25	0.4	v
VOL	Low-level output voltage	VIL = VIL max		IOL = 8 mA		A			0.35	0.5	1 *
II.	Input current at maximum input voltage	V _{CC} = MAX,	V ₁ = 7 V		40	A TO	0.1			0.1	mA
hн	High-level input current	V _{CC} = MAX,	V ₁ = 2.7 V	a. ?		C	20			20	μA
IL.	Low-level input current	$V_{CC} = MAX,$	V ₁ = 0.4 V	38 13		1.	-0.4			-0.4	mA
los	Short-circuit output current§	V _{CC} = MAX		C.L.	-20		-100	-20		100	mA
ICC	Supply current	V _{CC} = MAX,	See Note 2			7	13		7	13	mA

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. ‡All typical values are at $V_{CC} = 5 V$, $T_{\Delta} = 25^{\circ}C$. § Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second. NOTE 2. I_{CC} is measured with all outputs open and inputs grounded.

switching characteristics, $V_{CC} = 5 V$, $T_A = 25^{\circ} C$

	PARAMETER	TEST CONDITIONS	MIN	ТҮР	MAX	UNIT
****	Propagation delay time, high-to-low-level				05	
^t PHL	output from A, B, C, or D through 2 levels of logic			15	25	ns
*=+++	Propagation delay time, high-to-low-level	0 15-5			20	
τρηΓ	output from A, B, C, or D through 3 levels of logic	$C_L = 15 pF$,		20	30	ns
****	Propagation delay time, low-to-high-level	$R_{L} = 2 k \Omega,$		45	05	
^t PLH	output from A, B, C, and D through 2 levels of logic	See Note 3		15	25	ns
****	Propagation delay time, low-to-high-level				20	
^t PLH	output from A, B, C, and D through 3 levels of logic			20	30	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



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